

DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

ETECH CORD

ENGINEERING SPECIFICATIONS

Solid State Drives CVC Series Product Specification

niden



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.0 First release 2023/12/18



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

if TECH COR

Copyright 2021 Solid State Storage Technology Corporation Disclaimer

The information in this document is subject to change without prior notice in order to improve reliability, design, and function and does not represent a commitment on the part of the manufacturer. In no event will the manufacturer be liable for direct, indirect, special, incidental, or consequential damages arising out of the use or inability to use the product or documentation, even if advised of the possibility of such damages.

This document contains proprietary information protected by copyright.

All rights are reserved. No part of this datasheet may be reproduced by any mechanical, electronic, or other means in any form without prior written permission of *Solid State Storage Technology Corporation*.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Table of Contents 1 1.1 1.2 1.3 1.4 1.5 1.6 2 2.1 2.2 3 3.1 3.2 3.3 3.4 3.5 3.6 3.7 3.8 4 4.1 5 6



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1 INTRODUCTION

1.1 Overview:

The CVC SATA 6 Gb/s Solid State Drive (SSD) delivers leading performance in an industry standard M.2 and 2.5" form factor while simultaneously improving system responsiveness for mobile applications over standard rotating drive media or hard disk drives. By combining leading NAND flash memory technology with our innovative high-performance firmware, SOLID STATE STORAGE delivers a SSD for native Serial Advanced Technology Attachment (SATA) hard disk drive drop-in replacement with enhanced performance, reliability, ruggedness and power savings. Since there are no rotating platters, moving heads, fragile actuators, or unnecessary delays due to spin-up time or positional seek time that can slow down the storage subsystem, significant I/O and throughput performance improvement is achieved as compared to rotating media or hard disk drives. This document describes the specifications of the CVC SATA SSD.

The CVC SSD primarily targets SATA based servers, fan less laptop PCs, highly rugged mobile client devices, as well as thin and light mini/sub-notebooks. Key attributes include high performance, low power, increased system responsiveness, high reliability, and enhanced ruggedness as compared to standard mobile SATA hard drives. The CVC SSD is available in both M.2 and 2.5" form factors that are electrically, mechanically, and software compatible with existing M.2 Serial ATA slots and cables. Our flexible design allows interchangeability with existing mobile hard drives based on the SATA interface standard.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2 Product Specification

1.2.1. Form Factor & Capacity:

Table 1-1 Product number, Capacity and Form Factor

_				
[Model Name	Capacity	Form Factor	
	CVC-4D128	128 GB	M.2 Type 2242-S2-B-M	
	CVC-4D256	256 GB	M.2 Type 2242-D2-B-M	
	CVC-4D512	512 GB	M.2 Type 2242-S2-B-M	
	CVC-4D1024	1024 GB		
	CVC-4D2048	2048 GB	M.2 Type 2242-D2-B-M	
	CVC-8D128	128 GB		
	CVC-8D256	256 GB		
	CVC-8D512	512 GB	M.2 Type 2280-S2-B-M	
_	CVC-8D1024	1024 GB		
_	CVC-8D2048	2048 GB		
_	CVC-CD128	128 G <mark>B</mark>		
	CVC-CD256	256 GB	KA	
	CVC-CD512	512 GB	2.5″	
_	CVC-CD1024	1024 GB		
	CVC-CD2048	2048 GB	he C	Z ,
	CVC-4T128	128 GB	M.2 Type 2242-S2-M	γ_{0}
	CVC-4T256	256 GB	M.2 Type 2242-D2-B-M	"LON.
	CVC-4T512	512 GB	M.2 Type 2280-S2-M	
	CVC-4T1024	1024 GB	M.2 Type 2242-D2-B-M	
	CVC-8T128	128 GB		
_	CVC-8T256	256 GB		
	CVC-8T512	512 GB	M.2 Type 2280-S2-B-M	
	CVC-8T1024	1024 GB		
	CVC-CT128	128 GB		
	CVC-CT256	256 GB	2.5″	
	CVC-CT512	512 GB		
	CVC-CT1024	1024 GB		



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Table 1-2 Product number, Capacity and Form Factor for Capacity Clipping

Γ	Model Name	Capacity	Form Factor	
	CVC-4D120	120 GB	M.2 Type 2242-S2-B-M	
	CVC-4D120	240 GB	M.2 Type 2242-D2-B-M	
	CVC-4D480	480 GB	M.2 Type 2242-S2-B-M	
		570		



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Y. CORD

1.2.2. User Addressable Sectors:

Unformatted conscitu	Total user addressable sectors
Unformatted capacity	in LBA mode
128GB	250,069,680
256GB	500,118,192
512GB	1,000,215,216
1024GB	2,000,409,264
2048GB	4,000,797,360

Table 2-2 User Addressable Sectors for Capacity Clipping

Unformatted capacity	Total user addressable sectors
omormatted capacity	in LBA mode
120GB	234,441,648
240GB	468,862,128
480GB	937,703,088

Notes:

1). 1GB=1,000,000,000 bytes and not all the memory can be used for storage.

2). 1 Sector = 512 bytes

1.2.3. Flash:

Triple-Level Cell (TLC) component with Toggle-Mode



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

-Opp

1.2.4. Band Performance

Table 3 Maximum Sustained Read and Write Bandwidth on Windows 10 platform

Capacity	Access Type	MB/s (typ.)
128 GB	Sequential Read	Up to 550
120 GB	Sequential Write	Up to 450
256 GB	Sequential Read	Up to 550
240 GB	Sequential Write	Up to 480
512 GB	Sequential Read	Up to 550
480 GB	Sequential Write	Up to 490
100100	Sequential Read	Up to 550
1024 GB	Sequential Write	Up to 500
2048 GB	Sequential Read	Up to 550
2048 GB	Sequential Write	Up to 510
	ATTO	

Notes:

1). Performance measured using Crystal Disk Mark 7.0.0, QD8 T1, 1GiB test size, 5 cycles.

- 2). Write cache enabled & 4K boundary data.
- 3). Test by secondary drive (data drive & clean state) under SATA 6Gb/s.
- 4). Test platform: ASUS Z370 PRO (Windows 10 x64)
- 5). These values obtained in specific test environment at SSSTC and for reference purpose only. SSSTC

does not warrant those values.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

H. CORE

1.2.5. Read and Write IOPS

Table 4 Random Read/Write Input/Output Operations per Second on Windows 10 platform

	Capacity	Capacity Access Type IC		
	128 GB	4K Random Read	38,000	
	120 GB	4K Random Write	65,000	
	256 GB	4K Random Read	50,000	
	240 GB	4K Random Write	70,000	
	512 GB 4K Random Read		60,000	
	480 GB 4K Random Write		70,000	
	1034 CD	4K Random Read	65,000	
	1024 GB	4K Random Write	70,000	
/	2048 GB	4K Random Read	65,000	
	2048 GB	🔰 🗸 4K Random Write	75,000	

Notes:

1). Performance measured using Crystal Disk Mark 7.0.0, QD32 T16, 1GiB test size, 5 cycles.

2). Write cache enabled & 4K boundary data.

3). Test by secondary drive (data drive & clean state) under SATA 6Gb/s.

4). Test platform: ASUS Z370 PRO (Windows 10 x64)

These values which are written as "typ." are the values obtained in specific test environment at SSSTC

and for reference purpose only. SSSTC does not warrant those values.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2.6. Ready Time

Table 5 Power on to Ready time Specifications

Туре	Average Latency	Sudden POR	
Power on to Ready	500ms	10s	
Resume from DEVSLP	100ms	-	

Notes:

1). Device measured form power-on to ready to receive first Media command.

2). Power On To Ready time assumes drive have normal shutdown process which have STANDBY IMMEDIATE command. Time varies and 90% within 10 seconds if shutdown is not preceded by STANDBY IMMEDIATE command.

- 3). Test results may be different on different platform.
- 4). Typical POR assumes proper shutdown (Power removal preceded by host Shutdown Notification)

1.2.7. Power Management

-- SATA interface power management

1.2.8. Compatibility

- -- SATA Revision 3.0 compliant
- ETECH COOL Compatible with SATA 1.5Gb/s, 3.0Gb/s & 6.0Gb/s interface rates
- -- ATA/ATAPI- 8 compliant
- -- SSD enhanced SMART ATA feature set
- -- Native Command Queuing (NCQ) command set
- -- TRIM supported

1.2.9. Power Management

-- SATA interface power management



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2.10. Power Consumption

Table 6 Operating Voltage & Current

Form-Factor	Description	Min	Max	Unit
2.5" Model	Operating voltage for 5V (+/- 5%)	4.75	5.25	v
M.2 Model	Operating voltage for 3.3V (+/- 5%)	3.135	3.465	v

Capacity	Mode	I/О Туре	Тур.	Max.	Unit
		Read	0.9	1.5	W
128GB	Operating	Write	0.9	1.5	W
120GB	DEVSLP	-	-	5	mW
		Read	1	1.5	W
256GB	Operating	Write	1	1.5	W
240GB	DEVSLP	- 1.) /	-	5	mW
		Read		1.5	W
512GB	Operating	Write	1	1.5	W
480GB	DEVSLP		-	5	mW
		Read	1	2	W
1024GB	Operating	Write		2	W
	DEVSLP	-	5	5	mW
		Read	10	2	W
2048GB	Operating	Write	1	2	w
	DEVSLP	-	-	5	mW

Table 7 Power Consumption



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2.11. Temperature

Table 8 Temperature Relative Specifications					
Environmental Class	Environment	Mode	Min	Max	Unit
	Ambient	Operating	-25	85 ¹	°C
	Temperature	Non-operating	-40	85	°C
WT-L		Operation	5	95	%
	Humidity	Non-operation	5	95	%
	Ambient	Operating	-40	85 ¹	°C
	Temperature	Non-operating	-40	85	°C
WT	Humidity	Operation	5	95	%
VUC		Non-operation	5	95	%

Note:

1 Operating temperature is defined +85°C which refers to the surface temperature of flash memory.

2 Measured without condensation.

1.2.12. Certifications

Table 9 Device Certifications

Certification	Description
	Indicates conformity with the essential health and safety
CE compliant	requirements set out in European Directives Low voltage
	Directive and EMC Directive
	Underwriters Laboratories, Inc. Component Recognition
UL certified	UL60950-1
	Compliance to the Taiwan EMC standard "Limits and methods
BSMI	of Radio Disturbance Characteristics of Information Technology
	Equipment, CNS 13438 Class B"
Microsoft WHQL	Microsoft Windows Hardware Quality Labs
RoHS compliant	Restriction of Hazardous Substance Directive



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2.13. Reliability

Table 10 Reliability specifications

Parameter	Value
Mean Time between Failure (MTBF) ¹	> 3,000,000 hours
Power on/off cycle ²	50,000 cycles

Notes:

1). MTBF is calculated based on a Part Stress Analysis. It assumes nominal voltage with all other parameters within specified range.

2). Power on/off cycles is defined as power being removed from the drive, and the restored. Most host systems remove power from the drive when entering suspend and hibernate as well as on a system shutdown.

onfoemist SCH COO



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

ETECH COD

1.2.14. Shock and Vibration

Table 11 Shock and Vibration				
Item	Mode	Timing/Frequency	Max	
Shock ¹	Operating Non-operating	At 0.5 msec half-sine	1500G	
Vibration ²	Operating Non-operation	10-2000 Hz	20 G Peak	

Notes:

1). Shock specifications assume that the SSD is mounted securely with the input vibration applied to the drive mounting screws. Stimulus may be applied in the X, Y or Z axis.

2). Vibration specifications assume that the SSD is mounted securely with the input vibration applied to the drive mounting screws. Stimulus may be applied in the X, Y or Z axis. The measured specification is in root mean squared form.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

1.2.15. Electrostatic discharge (ESD)

Electromagnetic Immunity tests assume the SSD is properly installed in the representative host system. The drive operates properly without errors degradation in performance when subjected to radio frequency (RF) environments defined in the following table.

Test	Description	Performance criteria	Reference standard
Electrostatic discharge	Contact ±4KV Air: ±8KV	А	IEC 61000-4-2:2008
Electrostatic discharge	Contact ±6KV Air: ±12KV	В	IEC 61000-4-2:2008
Electrostatic discharge	Contact ±8KV Air: ±15KV	С	IEC 61000-4-2:2008
Radiated RF immunity	80~1000MHz, 3V/m, 80% AM with 1 KHz sine 900 MHz, 3 V/m, 50% pulse modulation at 200Hz	А	IEC 61000-4-3:2008
Electrical fast transient	±1KV on AC mains ±0.5KV on external I/O	В	IEC 61000-4-4:2004 +Corr.1:2006 +Corr.2:2007
Surge immunity	±1KV differential ±2KV common, AC mains	В	IEC 61000-4-5:2005
Conducted RF immunity	150KHz~80 MHz, 3 Vrms, 80% AM with 1KHz sine	A	IEC 61000-4-6:2008
Power frequency magnetic field	50Hz, 1A/m (r.m.s.)	A	IEC 61000-4-6:2008

Table 12 Radio Frequency Specifications

Notes:

- Performance criterion A = The device shall continue to operate as intended, i.e., normal unit operation with no degradation of performance.
- Performance criterion B = The device shall continue to operate as intended after completion of test, however, during the test, some degradation of performance is allowed as long as there is no data loss operator intervention to restore device function.
- 3. Performance criterion C = Temporary loss of function is allowed. Operator intervention is acceptable to restore device function.
- 4. Contact electrostatic discharge is applied to drive enclosure.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

SETECH CON

1.2.16. Weight:

Form-factor:

2.5": 35g Max

M.2 2242: 4.5g Max

M.2 2280: 6.8g Max

1.2.17. Dimension:

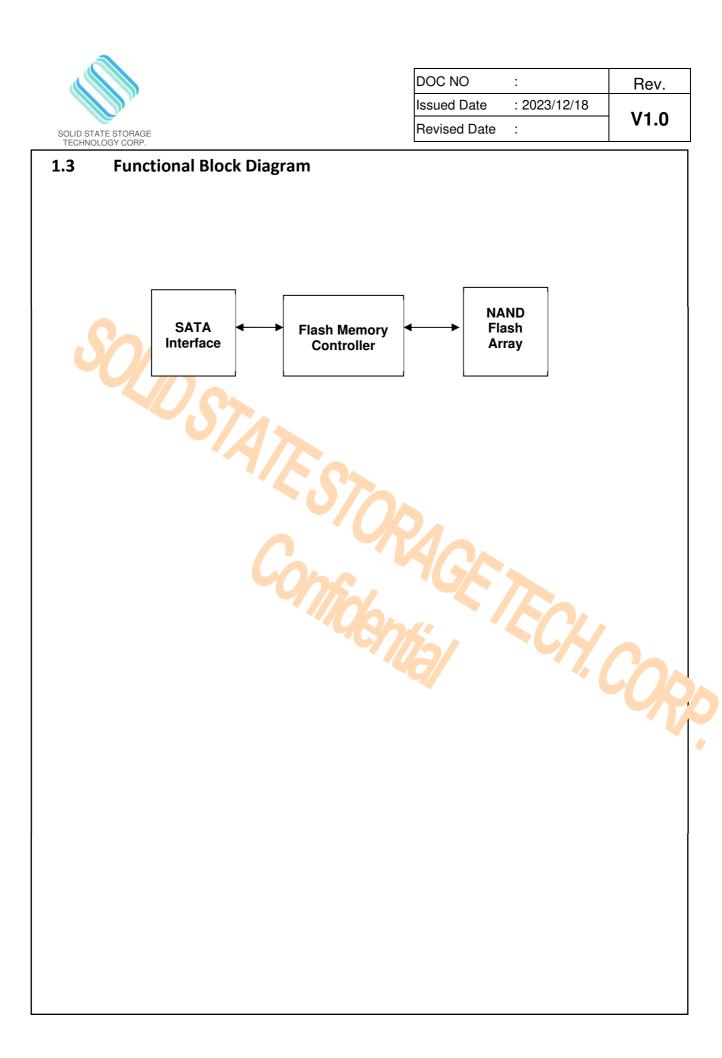
Form-factor:

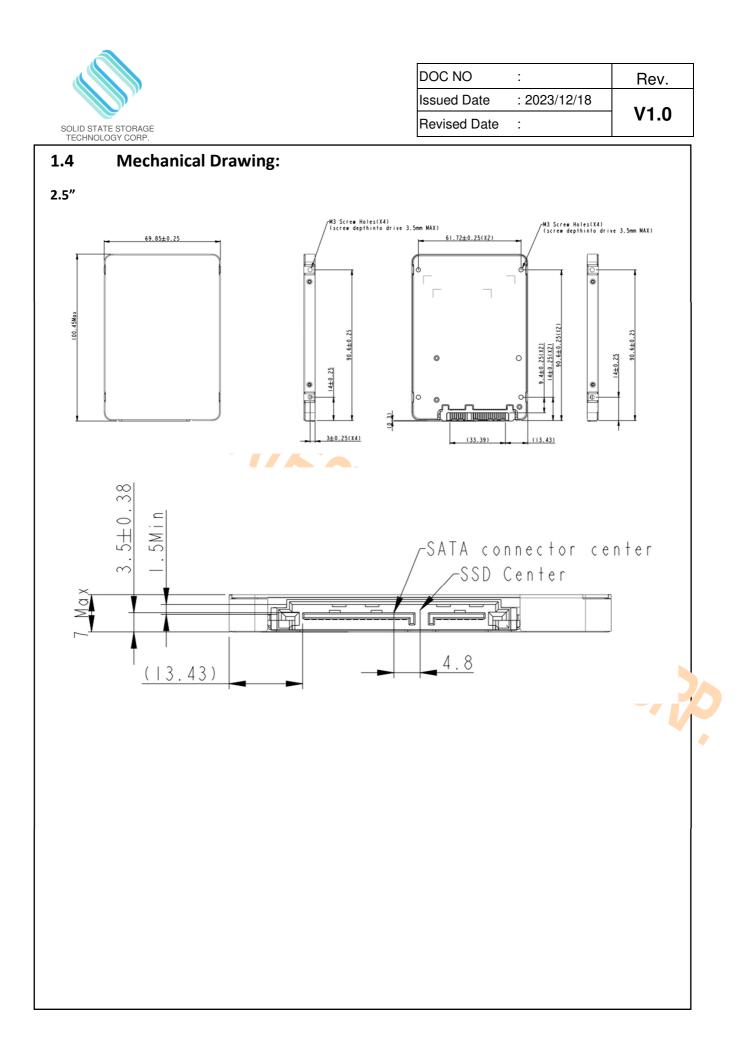
2.5": 100.45 mm x 69.85 mm x 7.00 mm (L x W x H)

M.<mark>2</mark> 2242-S2: 42.0 mm x 22.0 mm x 2.23 mm (L x W x H)

M.2 2242-D2: 42.0 mm x 22.0 mm x 3.58 mm (L x W x H)

M.2 2280-52: 80.0 mm x 22.0 mm x 2.23 mm (L x W x H)

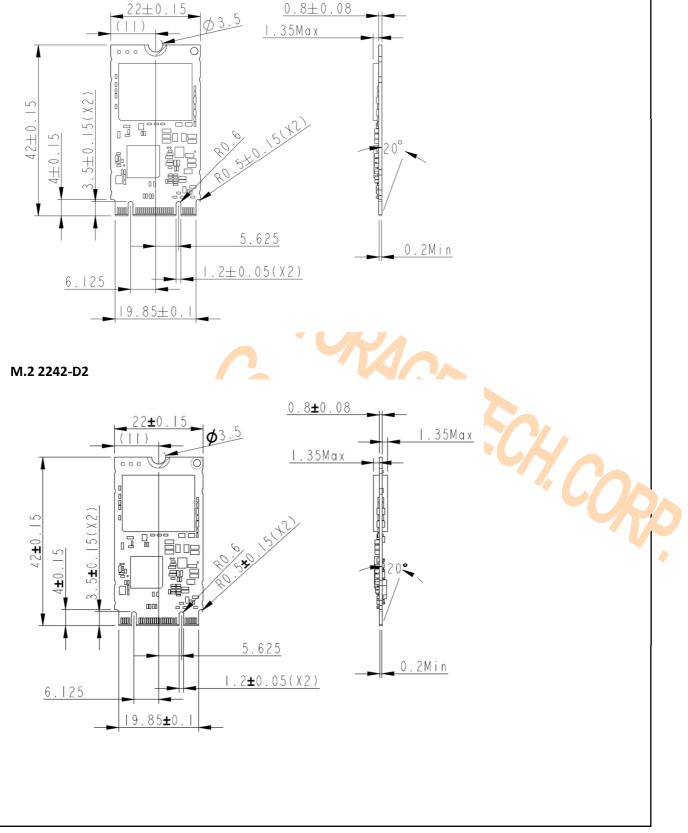






M.2 2242-S2

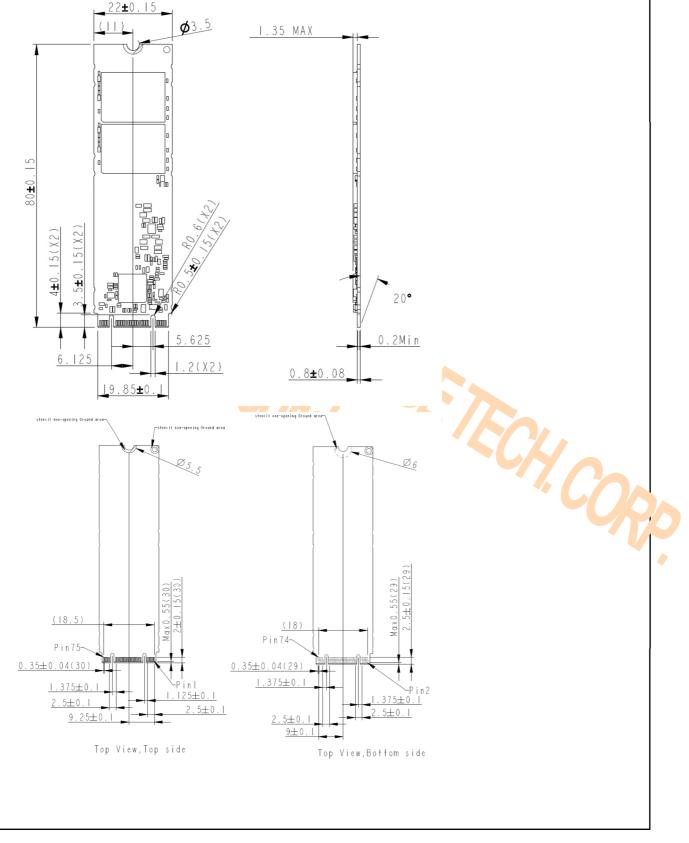
DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

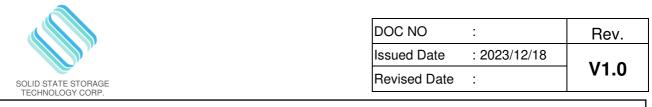




M.2 2280

DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0





Architecture 1.5

The CVC SATA 6Gb/s Solid State Drive (SSD) utilizes a cost-effective system-on-chip (SoC) design to provide a full 6Gb/s bandwidth with the host while managing multiple flash memory devices on multiple channels internally.

DEVSLP Power Mode: 1.6

SOLID STATE STORAGE SSD support DEVSLP power mode. After power up and enabled by a SET FEATURES command from the host, device will enter DEVSLP mode from any state after receive HW DEVSLP signal pin trigger. And return to Reset state after HW DEVSLP signal pin negated.

RAGE TECH CODO

TATESTO

min



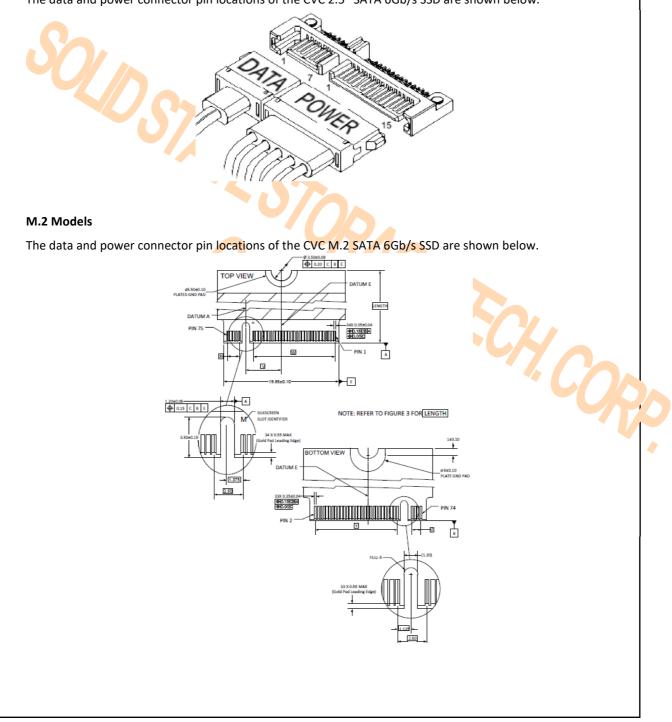
DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

2 PIN LOCATIONS AND SIGNAL DESCRIPTIONS

2.1 Pin Locations

2.5" Models

The data and power connector pin locations of the CVC 2.5" SATA 6Gb/s SSD are shown below.





DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Signal Descriptions 2.2

2.5" Models

Data Connector:

Table 13-1 2.5" Model Serial ATA Data Connector Pin Definitions

Name	Туре	Description
S1	GND	
S2	A+	Differential Signal Bair A
S3	A-	Differential Signal Pair A
S4	GND	
S5	В-	Differential Signal Dair D
<u>S6</u>	B+	Differential Signal Pair B
S7	GND	
Power Conn	ector:	

Power Connector:

Table 13-2 2.5" Model Serial ATA Power Connector Pin Definitions

Name	Type	Description	
P1	Retired	No Use	
P2	Retired		
Ρ3	Device Sleep Signal	If system didn't support DEVSLP, set DEVSLP Sleep Signal pin power high and keep (from power on), device will ignore. If system support DEVSLP, set DEVSLP Sleep Signal pin power low (from power on), device will support DEVSLP function. Device Sleep Signal H: SSD enter sleep mode. Device Sleep Signal L: SSD exit sleep mode.	
P4	GND		
P5	GND		
P6	GND		
P7	V5	5V Power, Pre-change	
P8	V5	5V Power	
P9	V5	5V Power	
P10	GND		
P11	DAS	Device Activity Signal	
P12	GND		
P13	V12	No Use	
P14	V12	No Use	
P15	V12	No Use	



DOC NO	:	Rev.	
Issued Date	: 2023/12/18	V1.0	
Revised Date	:		

M.2 Models

Data Connector:

Table 13-3 M.2 Model Serial ATA Data Connector Pin Definitions

Name	Туре	Description	
P1	CONFIG_3	This pin is following standard spec connect to ground.	
P2	3.3V AUX	Supply pin, 3.3V	
P3	GND	Ground	
P4	3.3V AUX	Supply pin, 3.3V	
P5	Not Available	no connect on SSD	
P6	Not Available	no connect on SSD	
P7	Not Available	no connect on SSD	
P8	Not Available	no connect on SSD	
P9	Not Available	no connect on SSD	
P10	DAS#	Device Activity Signal	
P11	Not Available	no connect on SSD	
P12	(Removed for key)	Mechanical Notch B (Removed for Key)	
P13	(Removed for key)	Mechanical Notch B (Removed for Key)	
P14	(Removed for key)	Mechanical Notch B (Removed for Key)	
P15	(Removed for key)	Mechanical Notch B (Removed for Key)	
P16	(Removed for key)	Mechanical Notch B (Removed for Key)	
P17	(Removed for key)	Mechanical Notch B (Removed for Key)	
P18	(Removed for key)	Mechanical Notch B (Removed for Key)	
P19	(Removed for key)	Mechanical Notch B (Removed for Key)	
P20	Not Available	no connect on SSD	
P21	CONFIG_0	This pin is following standard spec connect to ground.	
P22	Not Available	no connect on SSD	
P23	Not Available	no connect on SSD	
P24	Not Available	no connect on SSD	
P25	Not Available	no connect on SSD	
P26	Not Available	no connect on SSD	
P27	GND	Ground	
P28	Not Available	no connect on SSD	
P29	Not Available	no connect on SSD	
P30	Not Available	no connect on SSD	
P31	Not Available	no connect on SSD	
P32	Not Available	no connect on SSD	
P33	GND	Ground	
P34	Not Available	no connect on SSD	
P35	Not Available	no connect on SSD	
P36	Not Available	no connect on SSD	
P37	Not Available	no connect on SSD	
		If system didn't support DEVSLP, set Device Sleep Signal high and keep (from power on), device will ignore.	
P38	Device Sleep Signal	If system support DEVSLP, set Device Sleep Signal low (from	
		power on) device, device will support DEVSLP function as below:	
		Device Sleep Signal H: SSD enter sleep model.	
		Device Sleep Signal L: SSD exit sleep model.	
P39	GND	Ground	
P40	Not Available	no connect on SSD	



DOC NO	:	Rev.	
Issued Date	: 2023/12/18		
Revised Date	:	V1.0	

Table 13-4 M.2 Model Serial ATA Data Connector Pin Definitions

Name	Туре	Description	
P41	SATA-B+/PETn0	Host receiver differential signal pair	
P42	Not Available	no connect on SSD	
P43	SATA-B-/PETp0	Host receiver differential signal pair	
P44	Not Available	no connect on SSD	
P45	GND	Ground	
P46	Not Available	no connect on SSD	
P47	SATA-A-/PERn0	Host transmitter differential signal pair	
P48	Not Available	no connect on SSD	
P49	SATA-A+/PERp0	Host transmitter differential signal pair	
P50	Not Available	no connect on SSD	
P51	GND	Ground	
P52	Not Available	no connect on SSD	
P53	Not Available	no connect on SSD	
P54	Not Available	no connect on SSD	
P55	Not Available	no connect on SSD	
P56	MFG1	Manufacturing pin. Use determined by vendor. Must be a no-	
P30	MFG1	connect on the host board	
P57	GND	Ground	
P58	MFG2	Manufacturing pin. User determined by vendor. Must be a no-	
F 38	WII G2	connect on a host board	
P59	(Removed for <mark>k</mark> ey)	Mechanical Notch M (Removed for Key)	
P60	(Removed for key)	Mechanical Notch M (Removed for Key)	
P61	(Removed for key)	Mechanical Notch M (Removed for Key)	
P62	(Removed for key)	Mechanical Notch M (Removed for Key)	
P63	(Removed for key)	Mechanical Notch M (Removed for Key)	
P64	(Removed for key)	Mechanical Notch M (Removed for Key)	
P65	(Removed for key)	Mechanical Notch M (Removed for Key)	
P66	(Removed for key)	Mechanical Notch M (Removed for Key)	
P67	Not Available	no connect on SSD	
P68	SUSCLK	no connect on SSD	
P69	CONFIG_1	This pin is follow standard spec connect to ground.	
P70	3.3V AUX	Supply pin, 3.3V	
P71	GND	Ground	
P72	3.3V AUX	Supply pin, 3.3V	
P73	GND	Ground	
P74	3.3V AUX	Supply pin	
P75	CONFIG_2	This pin is following standard spec connect to ground.	



DOC NO	:	Rev.	
Issued Date	: 2023/12/18		
Revised Date	:	V1.0	

FIECH COD

3 ATA COMMAND SETS

3.1 ATA Command

The SSD supports all the mandatory ATA commands defined in the ATA/ATAPI-8 specification.

3.1.1 ATA General Feature Command Set

The SSD supports the ATA General feature Command set (non-packet), which consists of

- EXECUTE DEVICE DIAGNOSTIC
- FLUSH CACHE
- · IDENTIFY DEVICE
- · READ DMA
- READ DMA WITHOUT RETRIES
- READ SECTOR(S)
- READ SECTORS(S) WITHOUT RETRIES
- READ VERIFY SECTORS(S)
- READ VERIFY SECTORS(S) WITHOUT RETRIES
- SEEK
- $\cdot\,$ SET FEATURES
- WRITE DMA
- · WRITE DMA WITHOUT RETRIES
- WRITE SECTOR(S)
- · WRITE SECTOR(S) WITHOUT RETRY
- READ MULTIPLE
- · SET MULTIPLE MODE
- WRITE MULTIPLE
- · INITIALIZE DEVICE PARAMETERS
- · DATA SET MANAGEMENT
- The SSD supports all the following optional commands
 - · READ BUFFER
 - WRITE BUFFER
 - · DOWNLOAD MICROCODE

	DOC NO :	Rev.
	Issued Date : 2023/12/18	V4 0
SOLID STATE STORAGE	Revised Date :	V1.0
TECHNOLOGY CORP.		

3.1.2 Identify Device Data

The following table details the sector data returned after issuing an IDENTIFY DEVICE command.

Tab	le 14-1	Returned	Sector	Data

Word	F=Fixed V=Variable X=Both	Default Value	Description
0	F	0040h	General configuration bit-significant information
1	F	3FFFh	Obsolete-Number of logical cylinders (16,383)
2	F	C837h	Specific configuration
3	F	0010h	Obsolete-Number of logical heads (16)
4-5	F	0000h	Retired
6	F	003Fh	Obsolete-Number of logical sectors per logical track (63)
7-8	F	0000h	Reserved for assignment by the Compact Flash Association
9	F	0000h	Retired
10-19	V	Var.	Serial number (20 ASCII characters)
20-22	F	0000h	Retired / Obsolete
23-26	V	Var.	Firmware revision (8 ASCII characters)
27-46	V	Var.	Model number
47	F	8002h	7:0 – Maximum number of sectors transferred per interrupt on multiple commands
48	F	4000h	Trusted Computing feature set options, bit14 should be 1
49	F	2 <mark>F00h</mark>	Capabilities
50	F	4000h	Capabilities
51-52	F	0000h	Obsolete
53	F	0007h	Words 88 and 70:64 valid
54	V	Var.	Obsolete - Number of logical cylinders (16,383)
55	V	Var.	Obsolete - Number of logical heads (16)
56	V	Var.	Obsolete - Number of logical sectors per logical track (63)
57-58	V	Var.	Capacity (Cylinders*heads*sectors)
59	v	0101h	Number of sectors transferred per interrupt on multiple commands
60-61	V	250,069,680 (128GB) 500,118,192 (256GB) 1,000,215,216 (512GB)	Total number of user addressable logical sectors for 28-bit commands (DWord)
62	F	0000h	Obsolete
63	V	0007h	Multi-word DMA modes supported/selected
64	F	0003h	PIO modes supported
65	F	0078h	Minimum multiword DMA transfer cycle time per word
66	F	0078h	Manufacture's recommended multiword DMA transfer cycle time
67	F	0078h	Minimum PIO transfer cycle time without flow control
68	F	0078h	Minimum PIO transfer cycle time with IORDY flow control
69-70	F	4D20h	Reserved (for future command overlap and queuing)



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Word	F=Fixed V=Variable X=Both	Default Value	Description
71-74	F	0000h	Reserved for the IDENTIFY packet DEVICE command
75	F	001Fh	4:0 Maximum Queue depth-1=31
76	V	070Eh	Serial ATA capabilities
77	V	Var.	Reserved for Serial ATA
78	V	014Ch	Serial ATA features supported
79	V	Var.	Serial ATA features enabled
80	F	03F0h	Major Version Number
81	F	0000h	Minor Version Number
82	F	746Bh	Commands and feature sets supported
83	F	7D01h	Commands and feature sets supported
84	F	4 163h	Commands and feature sets supported
85	V	3469h	Commands and feature sets supported or enabled
86	V	BC01h	Commands and feature sets supported or enabled
87	F	4163h	Commands and feature sets supported or enabled
88	V	407Fh	Ultra DMA modes
89	F	0003h	Time required for security erase unit completion
90	F	0003h	Time required for enhanced security erase completion
91	F	0 <mark>000h</mark>	Current advanced power management value
92	V	Var.	Master Password Identifier
93	V	0000h	Hardware reset result. The contents of bits (12:0) of this wo shall change only during the execution of a hardware reset.
94	F	0000h	Current AAM value
95	F	0000h	Stream Minimum Request Size
96	F	0000h	Streaming Transfer Time - DMA
97	F	0000h	Streaming Access Latency - DMA and PIO
98-99	F	0000h	Streaming Performance Granularity
100-103	V	125,045,424 (64GB) 250,069,680 (128GB) 500,118,192 (256GB)	Maximum user LBA for 48-bit Address feature set
104	F	0000h	Streaming Transfer Time - PIO
105	F	0008h	Maximum number of 512-byte blocks per DATA SET MANAGEMENT command
106	F	4000h	Physical sector size/logical sector size
107	F	0000h	Inter-seek delay for ISO-7779 acoustic testing in microsecor
108-111	V	0000h 0000h 0000h 0000h	World wide name
112-115	F	0000h	Reserved for word wide name extension to 128 bits
116	F	0000h	Reserved for TLC
117-118	F	0000h	Words per logical sector
119	F	401Ch	Commands and feature sets supported
120	F	401Ch	Commands and feature sets supported or enabled



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Table 14-3 Returned Sector Data				
Word	F=Fixed V=Variable X=Both	Default Value	Description	
121-126	F	0000h	Reserved for expanded supported and enabled settings	
127	F	0000h	Removable Media Status Notification feature set support	
128	V	0021h	Security status	
129-159	F	0000h	Vendor specific	
160	F	0000h	Compact Flash Association (CFA) power mode 1	
161-167	F	0000h	Reserved for the CompactFlash Association	
168	F	0007h		
169	F	0001h	DATA SET MANAGEMENT command is supported	
170-173	V	Var.	Additional Product Identifier (ATA String)	
174-175	F	0000h	Reserved	
176-205	F	0000h	Current media serial number (ATA string)	
206	F	003Dh	SCT Command Transport	
207-208	F	0000h	Reserved	
209	F	4000h	Alignment of logical blocks within a physical block	
210-211	F	0000h	Write-Read-Verify Sector Count Mode 3 (DWord)	
212-213	F	0000h	Write-Read-Verify Sector Count Mode 2 (DWord)	
214	F	0000h	NV Cache Capabilities	
215-216	F	0000h	NV Cache Size in Logical Blocks (DWord)	
217	F	0001h	Nominal media rotation rate	
218	F	0000h	Reserved	
219	F	0000h 🗸	NV Cache Options	
220	F	0000h	7:0 Write-Read-Verify feature set current mode	
221	F	0000h	Reserved	
222	F	107Fh	Transport major version number	
223	F	0000h	Transport minor version number	
224-229	F	0000h	Reserved	
230-233	F	0000h	Extended Number of User Addressable Sectors (QWord) 🛛 🧹	
234	F	0001h	Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h	
235	F	0200h	Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h	
236-254	F	0000h	Reserved	
255	V	Var.	Integrity word	
	121-126 127 128 129-159 160 161-167 168 169 170-173 174-175 176-205 207-208 207-208 207-208 207-208 207-208 207-208 207-208 210-211 212-213 214-219 215-216 217 218 219 210-211 212-213 214-229 220 221 221 223 224-229 230-233	Word V=Variable X=Both 121-126 F 127 F 128 V 129-159 F 160 F 160 F 160 F 160 F 160 F 161-167 F 168 F 169 F 170-173 V 174-175 F 206 F 207-208 F 210-211 F 210-213 F 210-214 F 212-213 F 214 F 215-216 F 217 F 218 F 219 F 220 F 221 F 223 F 224-229 F 230-233 F 234 F 235 F 236-254	Word V=Variable X=Both Default Value 121-126 F 0000h 127 F 0000h 128 V 0021h 129-159 F 0000h 160 F 0000h 161-167 F 0000h 168 F 0001h 169 F 0000h 170-173 V Var. 174-175 F 0000h 206 F 0000h 206 F 0000h 206 F 0000h 207-208 F 0000h 209 F 4000h 210-211 F 0000h 212-213 F 0000h 214 F 0000h 215-216 F 0000h 217 F 0000h 218 F 0000h 219 F 0000h 220 F 107Fh	

Table 14-3 Returned Sector Data

Note:

1. F=Fixed. The content of the word is fixed and does not change for removable media devices, these values may change when media is Removed or changed.

2. V=Variable. The state of at least one bit in a word is variable and may change depending on the state of the device or the commands executed by the device.

3. X=F or V. The content of the word may be fixed or variable.



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

FIECH COD

3.2 Power Management Command Set

The SSD supports the power management command set, which consists of

- · CHECK POWER MODE
- · IDLE
- · IDLE IMMEDIATE
- SLEEP
- · STANDBY
- STANDBY IMMEDIATE

3.3 Security Mode Feature Set

The SSD supports the Security Mode command set, which consist of

- SECURITY SET PASSWORD
- · SECURITY UNLOCK
- · SECURITY ERASE PREPARE
- · SECURITY ERASE UNIT
- · SECURITY FREEZE LOCK
- · SECURITY DISABLE PASSWORD

3.4 SMART Command Set

The SSD supports the SMART command set, which consist of



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

- · SMART ENABLE OPERATIONS
- · SMART DISABLE OPERATIONS
- · SMART ENABLE/DISABLE AUTOSAVE
- SMART RETURN STATUS

The SSD supports the following optional commands.

- · SMART EXECUTE OFF-LINE IMMEDIATE
- · SMART READ DATA
- SMART READ LOG
- SMART WRITE LOG

Table 15 SMART commands

Subcommand	Code	LBA Low value
SMART ATTRI <mark>BUTE</mark> VALUES (READ DATA)	D0h	
READ ATTRIBUTE THRESHOLDS	D1h	
ENABLE/DISABLE ATTRIBUTE AUTOSAVE	D2h	
SAVE ATTRIBUTE VALUES	D3h	
EXECUTE OFF-LINE IMMEDIATE	D4h	
EXECUTE SMART OFF-LINE ROUTINE		00h
EXECUTE SMART SHORT SELF-TEST ROUTINE (OFFLINE)		01h
EXECUTE SMART EXTENDED SELF-TEST ROUTINE (OFFLINE)		02h
ABORT OFF-LINE ROUTINE		7Fh
EXECUTE SMART SHORT SELF-TEST ROUTINE (CAPTIVE)		81h
EXECUTE SMART EXTENDED SELF-TEST ROUTINE (CAPTIVE)		82h
READ LOG SECTOR	D5h	
WRITE LOG SECTOR	D6h	
ENABLE SMART OPERATIONS	D8h	
DISABLE SMART OPERATIONS	D9h	
RETURN SMART STATUS	DAh	
Enable/Disable Automatic OFFLINE	DBh	



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

ETECH COO

3.5 Host Protected Area Command Set

The SSD supports the Host Protected Area command set which consists of the following events.

- · READ NATIVE MAX ADDRESS
- · SET MAX ADDRESS
- · READ NATIVE MAX ADDRESS EXT
- · SET MAX ADDRESS EXT

The SSD supports the following optional commands.

- SET MAX SET PASSWORD
- · SET MAX LOCK
- SET MAX FREEZE LOCK
- · SET MAX UNLOCK

3.6 48-Bit Address Command Set

The SSD supports the Host Protected Area command set, which consists of the following events.

- · FLUSH CACHE EXT
- · READ DMA EXT
- · READ NATIVE MAX ADDRESS EXT
- · READ SECTOR(S) EXT
- · READ VERIFY SECTOR(S) EXT
- · READ MULTIPLE EXT
- · SET MAX ADDRESS EXT
- · WRITE DMA EXT
- · WRITE MULTIPLE EXT
- · WRITE MULTIPLE FUA EXT
- · WRITE SECTOR(S) EXT



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

moentist IECH COR

3.7 Device Configuration Overlay Command Set

The SSD supports the Device configuration Overlay command set, which consists of the following events.

- · DEVICE CONFIGURATION FREEZE LOCK
- · DEVICE CONFIGURATION IDENTITY
- · DEVICE CONFIGURATION RESTORE
- · DEVICE CONFIGURATION SET

3.8 General Purpose Log Command Set

The SSD supports the general purpose log command set, which consists of the following events.

- READ LOG EXT
- · WRITE LOG EXT



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

Moential SCH Cook

4 SATA COMMAND SETS

4.1 SATA Command

The SATA 3.0 Specification is a super set of the ATA/ATAPI-8 specification with regard to supported commands. The SSD supports the following features which are unique to the SATA 3.0 Specification.

4.1.1. Software Settings Preservation

The SSD supports the SET FEATURES parameter to enable/disable the preservation of software settings.

4.1.2. Native Command Queuing

The SSD supports the Native Command Queuing (NCQ) command set, which includes the following events.

READ FPDMA QUEUED

· WRITE FPDMA QUEUED

Note: with a maximum queue depth equal to 32



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

5 REFERENCES

This document references standards defined by a variety of organizations as listed below.

Title Date Location http://www.vcci.or.jp/vcci_e/general/j Dec 2008 VCCI oin/index.html Search for material description July 2007 ROHS datasheet at http://intel.pcnalert.com July 2007 SFF-8144, 1.8" drive form factor http://www.sffcommittee.org February 2007 Serial ATA Revision 2.6 http://www.sata-io.org SFF-8223, 2.5" Drive w/Serial Attachment May 2006 http://www.sffcommittee.org Connector May 2005 SFF-8201, 2.5" drive form factor http://www.sffcommittee.org http://www.t13.org/ April 2004 ATA-7 Spec. Volume 1 Aug. 2009 ATA-8 Spec. Rev 2 http://www.t13.org/ International Electro Technical Commission EB61000 4-2 Personnel Electrostatic Discharge 2008 Immunity 2008 4-3 Electromagnetic compatibility (EMC) http://www.iec.ch 2004 4-4 Electromagnetic compatibility (EMC) 2005 4-5 Electromagnetic compatibility (EMC) 2008 4-6Electromagnetic compatibility (EMC) 2008 4-11 (Voltage variations) ENV 50204 (Radiated electromagnetic field http://www.iec.ch 2004 from digital radio telephones)

Table 16 Standards References



DOC NO	:	Rev.
Issued Date	: 2023/12/18	
Revised Date	:	V1.0

6 TERMS AND ACRONYMS

This document incorporates many industry- and device-specific words use the following list to define a variety of terms and acronyms.

Term	Definition	
ΑΤΑ	Advanced Technology Attachment	
ΑΤΑΡΙ	Advanced Technology Attachment Packet Interface	
BER	Bit Error Rate, or percentage of bits that have errors relative to the total number of bits received	
BIOS	Ba <mark>sic Input/Outpu</mark> t System	
Chipset	A term used to define a collection of integrated components required to make a PC function	
DIPM	Device Initiated Power Management The ability of the device to reques <mark>t</mark> SAT <mark>A link p</mark> ower state changes	
DMA	Direct Memory Access	
DRAM	Dynamic Random Access Memory	
EXT	Extended	
FP	First Party	
GB	Giga-byte defined as 1X10 ⁹ bytes	
НСІ	Host Controller Interface	
НСТ	Hardware Compatibility Test	
HDD	Hard Disk Drive	
	Host Initiated Power Management	
HIPM	The ability of the host to request SATA link power state changes	
Hot Plug	A term used to describe the removal or insertion of a SATA hard drive when the system is powered on	
IOPS	Input output operations per second	
LBA	Logical Block Address	
LPM	Link Power Management: the ability of the SATA link layer to enter one of two lower power consuming states, partial and slumber	
MB	Mega-bytes defined as 1x10 ⁶ bytes	
mSATA	Mini-SATA	

Table 17 Glossary of Terms and Acronyms

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Advantech:

96FD80-S128-TS